

GENERAL DESCRIPTION

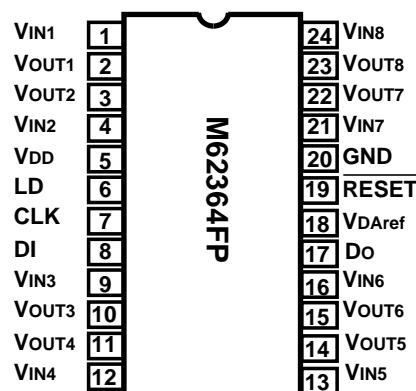
The M62364FP is a CMOS 8-bit, 8-ch D/A converter having a multiplying function and output buffer amplifiers. It has a serial data input and can easily communicate with a microcontroller by the simple three-wiring method (DI, CLK, LD).

The output buffer amplifiers operating in AB-class has both sinking and driving capabilities of 1.0mA or more and can operate in a whole supply range from VDD to GND.

The IC is suitable for a use in automatic adjustment applications in conjunction with a MCU by utilizing the terminal Do for a cascading connection.

FEATURES

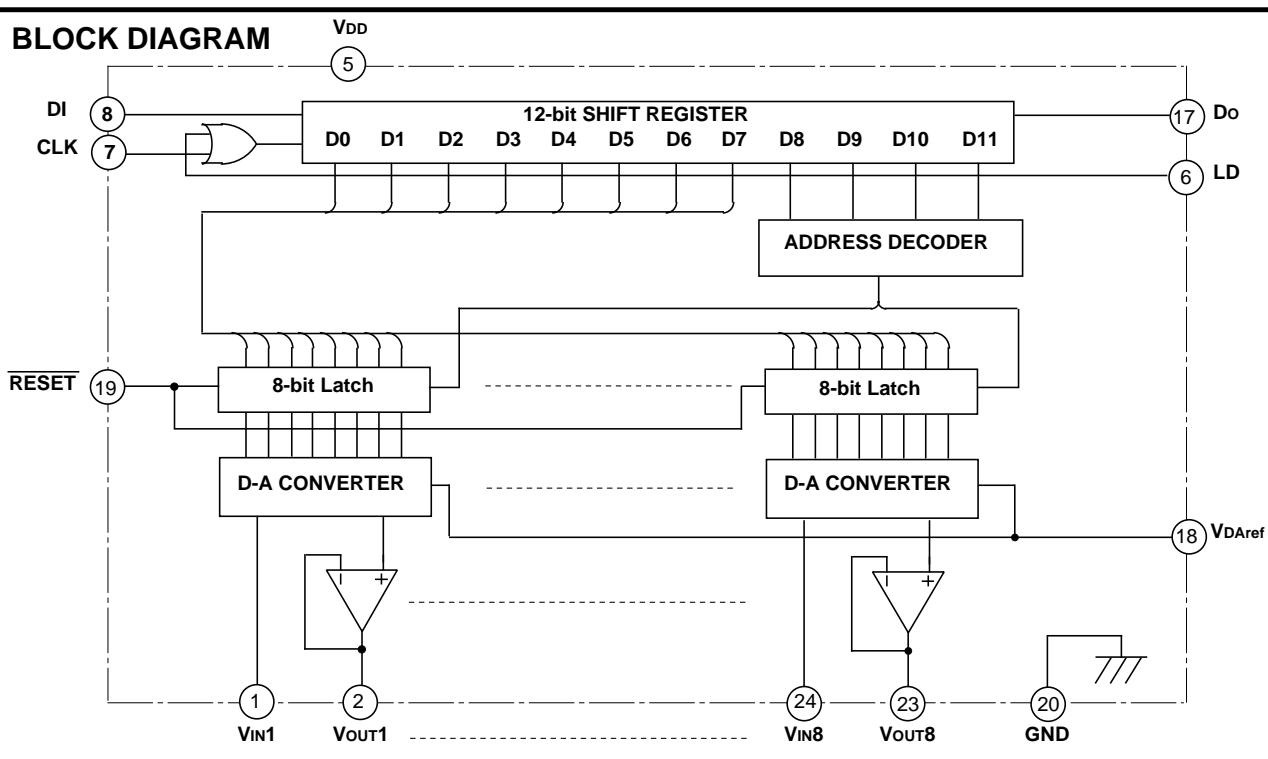
- Three-wiring serial data transmission
- Doubled precision 8-ch D/A converter employing an R-2R with higher-order segment method
- 8 buffer amplifiers operating in a whole supply voltage range from VDD to GND
- 4-quadrant multiplication

PIN CONFIGURATION (TOP VIEW)

Outline 24P2Q (FP)

APPLICATION

Digital to analog conversion for consumer and industrial equipment.
Gain setting and automatic adjustment of display-monitor and CTV.

BLOCK DIAGRAM

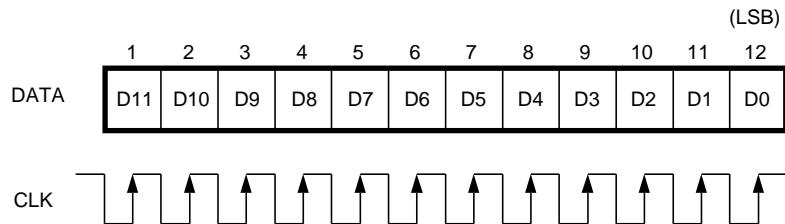
EXPLANATION OF TERMINALS

PIN No.	Symbol	Function
(8)	D I	Serial data input
(17)	Do	Serial data output
(7)	CLK	Shift clock input. Input data of DI are taken into the 12-bit shift register on a rising edge of the clock.
(6)	L D	A low state enables data loading to the 12-bit shift register. During a rising edge of LD, the data will be loaded to the output register.
(19)	RESET	Reset 8-bit latches
(2)	Vout1	D/A Converter Output with 8-bit resolution
(3)	Vout2	
(10)	Vout3	
(11)	Vout4	
(14)	Vout5	
(15)	Vout6	
(22)	Vout7	
(23)	Vout8	
(5)	VDD	Power Supply
(20)	GND	Ground
(1)	VIN1	D/A Converter Input
(4)	VIN2	
(9)	VIN3	
(12)	VIN4	
(13)	VIN5	
(16)	VIN6	
(21)	VIN7	
(24)	VIN8	
(18)	VDAref	D-A Converter Reference Voltage Input

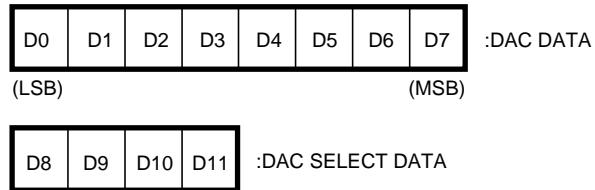


DIGITAL FORMAT

- 12BIT SERIAL DATA



- DATA ASSIGNMENT



Dac Select Data

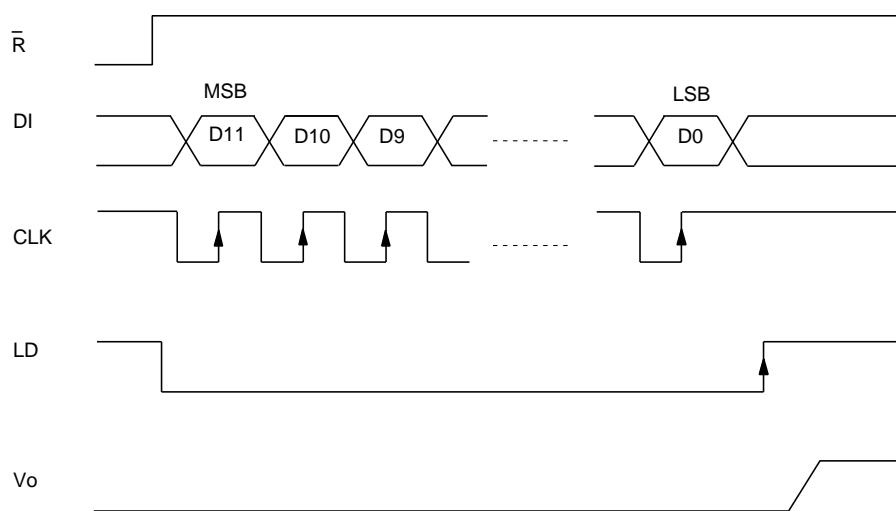
				Dac Selection
0	0	0	0	Don't Care
0	0	0	1	VOUT1 Selection
0	0	1	0	VOUT2 Selection
0	0	1	1	VOUT3 Selection
0	1	0	0	VOUT4 Selection
0	1	0	1	VOUT5 Selection
0	1	1	0	VOUT6 Selection
0	1	1	1	VOUT7 Selection
1	0	0	0	VOUT8 Selection
1	0	0	1	Don't Care
1	0	1	0	Don't Care
1	0	1	1	Don't Care
1	1	0	0	Don't Care
1	1	0	1	Don't Care
1	1	1	0	Don't Care
1	1	1	1	Don't Care



•Digital Data Format

D0	D1	D2	D3	D4	D5	D6	D7	DAC OUTPUT
0	0	0	0	0	0	0	0	V_{DAref}
1	0	0	0	0	0	0	0	$(V_{IN}-V_{DAref})/256 \times 1+V_{DAref}$
0	1	0	0	0	0	0	0	$(V_{IN}-V_{DAref})/256 \times 2+V_{DAref}$
1	1	0	0	0	0	0	0	$(V_{IN}-V_{DAref})/256 \times 3+V_{DAref}$
:	:	:	:	:	:	:	:	:
1	1	1	1	1	1	1	1	$(V_{IN}-V_{DAref})/256 \times 255+V_{DAref}$

TIMING CHART



* Input data carried out LD signal Low besides CLK signal positive edge.
CLK,LD is keep generally HIGH level.



ABSOLUTE MAXIMUM RATING

SYMBOL	PARAMETER	MEASUREMENT CONDITION	RATINGS	UNIT
VDD	Supply Voltage		-0.3 ~ +7.0	V
VIND	Digital Input Voltage		-0.3 ~ +7.0	V
VIN	Analog Input Voltage		-0.3 ~ VDD+0.3	V
VOUT	Analog Output Voltage		-0.3 ~ VDD+0.3	V
VDAref	D-A Reference Voltage		-0.3 ~ VDD+0.3	V
Topr	Operating Temperature		-20 ~ +75	°C
Tstg	Storage Temperature		-40 ~ +125	°C

ELECTRICAL CHARACTERISTICS

<Ana/Dig Common Part> (VDD=5V±10%, VDD≥VIN, GND, VDAref=0V, Ta=-20~85°C unless otherwise noted)

SYMBOL	PARAMETER	MEASUREMENT CONDITION	LIMIT			UNIT
			MIN	TYP	MAX	
VDD	Supply Voltage		2.7	3.0	3.6	V
IDD	Supply Current	CLK=1MHz, Vcc=3V, IAO=0μA			3.5	mA

<Digital Part> (VDD=5V±10%, VDD≥VIN, GND, VDAref=0V, Ta=-20~85°C unless otherwise noted)

SYMBOL	PARAMETER	MEASUREMENT CONDITION	LIMIT			UNIT
			MIN	TYP	MAX	
IILK	Input Leak Current	VIN=0 ~ VDD	-10		10	μA
IIL	Digital Input "Low" Voltage				0.2VDD	V
IIH	Digital Input "High" Voltage		0.8VDD			V
VOL	Do Terminal Output "Low" Voltage	IOL=2.5mA			0.4	V
VOH	Do Terminal Output "High" Voltage	IOH=-400μA	VDD-0.4			V

<Analog Part> (VDD=5V±10%, VDD≥VIN, GND, VDAref=0V, Ta=-20~85°C unless otherwise noted)

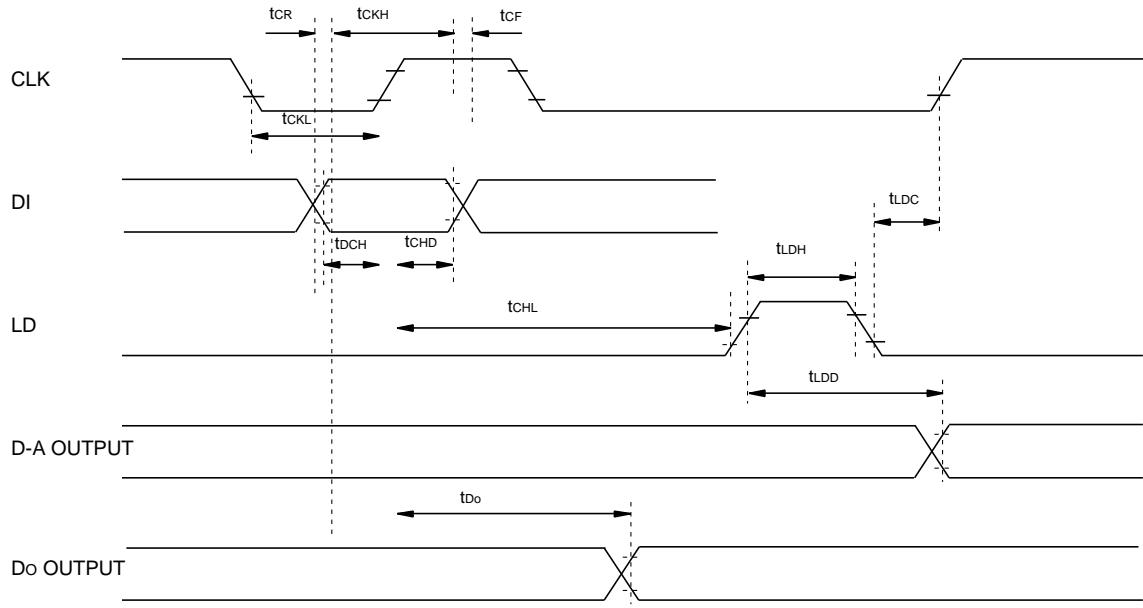
SYMBOL	PARAMETER	MEASUREMENT CONDITION	LIMIT			UNIT
			MIN	TYP	MAX	
IIN	Input Current	VIN=3V, VDAref=0V, *Proportional to max. input current condition(VIN-VDAref) and digital data of each channels.			0.18	mA
IDAref	D-A Reference Input Current	VIN=3V, VDAref=0V, *Proportional to max. input current condition(VIN-VDAref) and digital data of each channels.	-1.44			mA
RES	Resolution	VDD=2.61V, VDAref=0.050V(10mV/1LSB) Without load(IAO=±0)		8		bit
DNL	Differential Nonlinearity		-1		1	LSB
NL	Nonlinearity		-1.5		1.5	LSB
VAO	Buffer Amplifier Output Voltage Range	IAO=±100μA IAO=±500μA	0.1		Vcc-0.1	V
IAO	Buffer Amplifier Output Current Range	Upper Saturation Voltage=0.4V Lower Saturation Voltage=0.4V	0.2		Vcc-0.2	
Co	Output Capacititative Load		-1		1	mA
Ro	Buffer Amplifier Output Impedance			5		Ω



<AC Characteristics> ($V_{DD}=5V\pm10\%$, $V_{DD}\geq V_{IN}, GND, V_{DRef}=0V$, $T_a=-20\sim85^\circ C$, unless otherwise noted)

SYMBOL	PARAMETER	MEASUREMENT CONDITION	LIMIT			UNIT
			MIN	TYP	MAX	
tCKL	Clock "L" Pulse Width		200			nS
tCKH	Clock "H" Pulse Width		200			nS
tCR	Clock Rise Time				200	nS
tCF	Clock Fall Time					
tdCH	Data Set Up Time		60			nS
tCHD	Data Hold Time		100			nS
tCHL	LD Set Up Time		200			nS
tLDC	LD Hold Time		100			nS
tLDH	LD "H" Pulse Duration Time		100			nS
tDo	Data Output Delay Time	$C_L=100pF$	70		350	nS
tLDD	D-A Output Setting Time	$C_L\leq100pF, V_{AO}:0.1\leftrightarrow2.6V$ This Time Until The Output Becomes The final Value Of 1/2 LSB			300	μs

TIMING CHART



⚠ Mitsubishi Electric Corporation puts the maximum effort into making semiconductor products better and more reliable, but there is always the possibility that trouble may occur with them. Trouble with semiconductors may lead to personal injury, fire or property damage. Remember to give due consideration to safety when making your circuit design, in order to prevent fires from spreading, redundancy, malfunction or other mishap.

